

F1C200s Datasheet

Revision 1.0

Apr.18,2017



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Revision History

Revision	Date	Description	
1.0	Apr.18,2017 Initial Release Version		



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1. Overview

The F1C200s processor represents Allwinner's latest achievement in mobile applications processors. The processor targets the needs of video boombox markets.

The F1C200s is based on the ARM9 CPU architecture with a high degree of functional integration, and supports Full HD video playback, including H.264,H.263,MPEG1/2/4 decoder. Integrated audio codec and I2S/PCM interface provide end users with a good audio experience. TV-IN interface enables video input by connecting to video devices such as camera, and TV-OUT interface enables video output by connecting to TV devices.

To reduce the BOM costs, the F1C200s built-in DDR1 memory, and it is packed with general-purpose peripherals such as USB OTG, UART, SPI, TWI, TP, SD/MMC,CSI etc. The F1C200s outperforms competitors in terms of its powerful performance, low power consumption, and flexible scalability.

Applications:

- Video Playback
- Audio Playback
- FM



2. Features

2.1. CPU Architecture

The F1C200s platform is based on ARM9 CPU architecture.

- Five-stage pipeline architecture
- Support 16KByte D-Cache
- Support 32KByte I-Cache

2.2. Memory Subsystem

This section consists of internal memory and external memory:

- Boot ROM
- SDRAM
- SD/MMC Interface

Boot ROM

- Internal memory
- On-Chip ROM boot loader
- Support system boot from SPI Nor/Nand Flash, and SD/TF card
- Support system code download through USB OTG

SDRAM

• SIP DDR1

SD/MMC Interface

- External memory
- Support secure digital memory protocol commands (up to SD2.0)
- Support secure digital I/O protocol commands (up to SDIO2.0)
- Support multimedia card protocol commands (up to eMMC4.41)
- Support one SD (Verson1.0 to 2.0) or MMC (version 3.3 to eMMC4.41)
- Support hardware CRC generation and error detection
- Support host pull-up control
- Support SDIO interrupts in 1-bit and 4-bit modes
- Support SDIO suspend and resume operation
- Support SDIO read wait
- Support block size of 1 to 65535 bytes
- Support descriptor-based internal DMA controller
- Internal 128 bytes FIFO for data transfer
- Support 3.3V IO pad

2.3. System Peripheral

This section includes:

- Timer
- INTC
- CCU
- DMA
- PWM

Timer

• Three timers



- Support watchdog reset
- Support audio and video synchronize counter

INTC

- Support up to 64 interrupts
- Support 4-level priority
- Support interrupt mask
- Support interrupt fast forcing
- Support one external interrupt

CCU

- Support 6 PLLs
- Control of clock generation, division, distribution and gating
- Control of device software reset

DMA

- Support Normal DMA and Dedicated DMA
- Support two kinds of interrupt
- Support hardware continuous transfer mode

PWM

- Support two PWM outputs
- Support cycle mode and pulse mode
- Support 24MHz maximum output frequency

2.4. Display Subsystem

This section includes:

- Display Engine
- Display Output

Display Engine

- Support four layers overlay, each layer size up to 2048x2048 pixels
- Support Alpha blending / color key
- Support multi-format input formats
 - 1/2/4/8/16/32 bpp color
 - YUV444/YUV422/YUV420/YUV411
- Support hardware cursor
- Support scaling function for one layer
 - ARGB8888/YUV444/YUV420/YUV422/YUV411
 - Input and output size up to 1280x720 pixels
 - Resize ratio from 1/16X to 32X
 - 4-tap 32-phase anti-aliasing filter in horizontal and vertical direction
 - Scaler supports write-back to memory function

Display Output

- LCD RGB interface, TTL interface, up to 1280x720@60fps
- LCD Serial RGB interface, CCIR656 interface, up to 720x576@60fps
- LCD i8080 interface with 18/16/9/8 bit, up to 800x480@60fps
- LCD Dither function, support RGB666/RGB565 interface
- TV CVBS output, support NTSC/PAL, with auto plug detecting

2.5. Video Engine

• Support H.264 BP/MP/HP up to 1280x720@30fps decoding



- Support format MPEG1 and MPEG2 up to 1280x720@30fps decoding
- Support format MPEG4 SP/ASP GMC and H.263 including Sorenson Spark up to 1280x720@30fps decoding
- Support MJPEG encode up to 1280x720@30fps
- Support JPEG encode size up to 8192 x 8192
- Support JPEG decode size up to 16384 x 16384

2.6. Image Subsystem

This section includes:

- CSI
- CVBS Input

CSI

- Support 8-bit CMOS-sensor interface
- Support YUV camera up to 5Mega pixel
- Support CCIR656 protocol for NTSC and PAL

CVBS Input

- Support NTSC/PAL
- Support 3D comb filter
- Support two TV CVBS channels:TVIN0,TVIN1

2.7. Audio Subsystem

Audio Codec

- Two audio digital-to-analog(DAC) channels
- Stereo capless headphone drivers:
 - Up to 100dB DR
 - Supports DAC Sample Rates from 8KHz to 192KHz
- Support analog/ digital volume control
- Analog low-power loop from FM/ line-in /microphone to headphone outputs
- Three audio inputs:
 - One microphone input
 - Stereo FM left/right input
 - One Line-in input
- One audio analog-to-digital(ADC) channel
 - 96dB SNR@A-weight
 - Supports ADC Sample Rates from 8KHz to 48KHz
 - Support Auto Gain Control(AGC)

2.8. System Peripherals

This section includes:

- USB 2.0 OTG
- KEYADC
- TP
- Digital Audio Interface
- UART
- SPI
- TWI
- IR
- RSBTM



OWA

USB 2.0 OTG

- Support AMBA AHB Slave mode
- Support the Host Negotiation Protocol (HNP) and the Session Request Protocol (SRP)
- Support the UTMI+ Level 3 interface . The 8-bit bidirectional data buses are used.
- 64-Byte Endpoint 0 for Control Transfer (Endpoint0)
- Support High-Bandwidth Isochronous & Interrupt transfers
- Automated splitting/combining of packets for Bulk transfers
- Support point-to-point and point-to-multipoint transfer in both Host and Peripheral mode
- Include automatic ping capabilities
- Soft connect/disconnect function
- Perform all transaction scheduling in hardware
- Power Optimization and Power Management capabilities
- Include interface to an external Dedicated Central DMA controller. Data is transferred through Special bus for saving AHB bus bandwidth
- Support industry-standard single port SRAM for USB Configurable Data FIFO. The size is 2048 byte with 32-bit word width. The RAM can be used by other modules when USB OTG disable

KEYADC

- 6-bit resolution
- Support hold key and general key
- Support single key and continuous key
- Sample rate up to 250Hz

ΤP

- 12-bit SAR type analog-to-digital converter
- 4-wire I/F
- Dual Touch Detect
- Touch-pressure measurement
- Sampling frequency: 2MHz
- Single-Ended conversion of touch screen inputs and ratio metric conversion of touch screen inputs
- TACQ up to 262ms
- Median and averaging filter to reduce noise
- Pen down detection, with programmable sensitivity
- Support X, Y change function

Digital Audio Interface

- I2S or PCM configured by software
- Master / Slave Mode operation configured by software
- I2S Audio data sample rate from 8KHz to 192KHz
- I2S Data format for standard I2S, Left Justified and Right Justified
- PCM supports linear sample (8-bits or 16-bits), 8-bits u-law and A-law commanded sample

UART

- Three UART controllers
- Compatible with industry-standard 16550 UARTs
- Support IRDA version 1.0 SIR protocol with maximum baud rate to 115200bps for all UARTs
- Support for word length from 5 to 8 bits, an optional parity bit, and 1,1.5 or 2 stop bits
- Programmable parity(even,odd and no parity)
- 32-Bytes Transmit and receive data FIFOs
- Support DMA controller interface
- Software/ Hardware Flow Control
- Interrupt support for FIFOs, Status Change

SΡ

• Two SPI controllers



- Full-duplex synchronous serial interface
- Master/Slave configurable
- 8-bit wide by 64-entry FIFO for both transmit and receive data
- Polarity and phase of the chip select (SPI_SS) and SPI Clock (SPI_SCLK) are configurable

TWI

- Three TWI controllers
- Software-programmable for Slave or Master
- Support repeated START signal
- Multi-master systems supported
- Allow 10-bit addressing with TWI bus
- Performs arbitration and clock synchronization
- Own address and general call address detection
- Interrupt on address detection
- Support speeds up to 400Kbits/s ('fast mode')
- Allow operation from a wide range of input clock frequencies

IR

- Full physical layer implementation
- Support CIR for remote control
- 64x8bits FIFO for data buffer
- Programmable FIFO thresholds

RSB^{TM}

- Support speed up to 20MHz with ultra low power
- Support push-pull bus
- Support host mode
- Support programmable output delay of CD signal
- Support parity check for address and data transmission
- Support multi-devices

OWA

- EC-60958 transmitter functionality
- Support S/PDIF Interface
- Support channel status insertion for the transmitter
- Support Parity generation on the transmitter
- One 32×24bits FIFO (TX) for audio data transfer
- Programmable FIFO thresholds
- Interrupt and DMA support

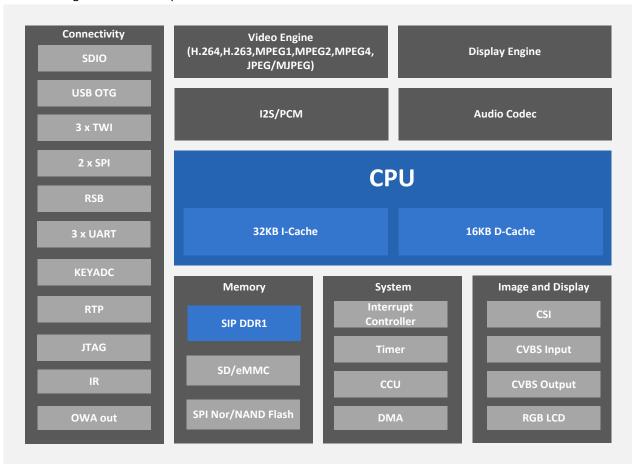
2.9. Package

QFN88,10mm x 10mm

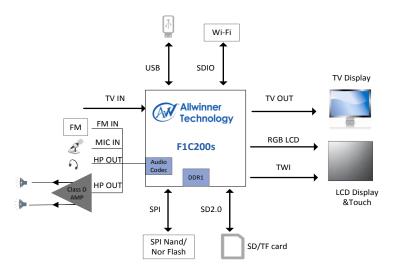


3.Block Diagram

The block diagram of F1C200s processor is as follows:



The typical application diagram of F1C200s is as follows:





4.Pin Description

4.1. Pin Characteristics

Following table describes the F1C200s pin characteristics from seven aspects: *BALL#, Pin Name, Default Function, Type, Reset* State, Default Pull Up/Down and Buffer Strength.

- (1). **Default function** defines the default function of each pin, especially for pins with multiplexing functions;
- (2). *Pin types*: O for output, I for input, I/O for input/output, A for analog, AI for analog input, AO for analog output, AI/O for analog input/output, OD for Open-Drain, P for power and G for ground;
- (3). *Reset state* defines the state of the terminal at reset: Z for high-impedance.
- (4). **Default Pull up/down** defines the presence of an internal pull up or pull down resistor. Unless otherwise specified, the pin is default to be floating, and can be configured as pull up or pull down;
- (5). **Buffer strength** defines the driver strength of the associated output buffer. It is tested in the condition that VCC= 3.0V, strength=MAX;

Pin Num ⁽¹⁾	Pin Name	Default Function	Pin Type ⁽²⁾	Reset State ⁽³⁾	Default Pull Up/ Down ⁽⁴⁾	Buffer Strength ⁽⁵⁾ (mA)
GPIOC						
59	PC0	GPIO	1/0	Disabled	-	-
60	PC1	GPIO	1/0	Disabled	Pull-up	-
61	PC2	GPIO	1/0	Disabled	-	-
62	PC3	GPIO	1/0	Disabled	-	-
GPIOD						
6	PD0	GPIO	1/0	Disabled	-	-
7	PD1	GPIO	I/O	Disabled	-	-
8	PD2	GPIO	I/O	Disabled	-	=
9	PD3	GPIO	1/0	Disabled	-	-
10	PD4	GPIO	1/0	Disabled	-	-
11	PD5	GPIO	1/0	Disabled	-	-
12	PD6	GPIO	1/0	Disabled	-	-
13	PD7	GPIO	1/0	Disabled	-	-
14	PD8	GPIO	1/0	Disabled	-	-
15	PD9	GPIO	1/0	Disabled	-	-
16	PD10	GPIO	1/0	Disabled	-	-
17	PD11	GPIO	1/0	Disabled	-	-
18	PD12	GPIO	1/0	Disabled	-	-
19	PD13	GPIO	1/0	Disabled	-	-
21	PD14	GPIO	1/0	Disabled	-	-
23	PD15	GPIO	1/0	Disabled	-	=
24	PD16	GPIO	1/0	Disabled	-	=
25	PD17	GPIO	1/0	Disabled	-	-
26	PD18	GPIO	1/0	Disabled	-	=
27	PD19	GPIO	1/0	Disabled	-	-
28	PD20	GPIO	1/0	Disabled	-	-
29	PD21	GPIO	1/0	Disabled	-	-
GPIOE						
49	PE0	GPIO	1/0	Disabled	-	-
48	PE1	GPIO	1/0	Disabled	-	-
47	PE2	GPIO	1/0	Disabled	-	-
46	PE3	GPIO	1/0	Disabled	-	-
45	PE4	GPIO	1/0	Disabled	-	-
44	PE5	GPIO	1/0	Disabled	-	-
43	PE6	GPIO	1/0	Disabled	-	-



42	PE7	GPIO	I/O	Disabled	-	-
41	PE8	GPIO	1/0	Disabled	-	-
40	PE9	GPIO	1/0	Disabled	-	-
39	PE10	GPIO	I/O	Disabled	-	-
38	PE11	GPIO	I/O	Disabled	-	-
37	PE12	GPIO	I/O	Disabled	-	-
GPIOF	I			1		l
58	PF0	GPIO	I/O	Disabled	T _	_
57	PF1	GPIO	1/0	Disabled	-	_
56	PF2	GPIO	1/0	Disabled	-	-
55	PF3	GPIO	1/0	Disabled	-	-
54	PF4	GPIO	1/0	Disabled	-	_
53		GPIO	1/0		1	-
	PF5	GPIO	1/0	Disabled	-	-
USB	Т			Т	T	T
67	UVCC	-	Р	-	-	-
68	USB-DM	-	Α	-	-	-
69	USB-DP	-	Α	-	-	-
Audio Codec						
81	VRA1	-	Α	-	-	-
83	VRA2	-	Α	-	-	-
82	AGND	-	Р	-	-	-
85	FMINR	-	Α	-	-	-
84	FMINL	-	Α	-	-	-
87	MICIN	-	Α	-	-	-
86	LINL	-	Α	-	-	-
88	HPR	-	Α	-	-	-
1	HPL	-	A	_	_	_
3	НРСОМ	-	A	_	-	_
4	HPVCC	_	P	_	-	_
2	HPCOMFB	-	A	-	-	-
80	AVCC	-	P	_	_	_
Touch Panel	7.000	<u> </u>	1 '		1	
	TPX1	-	Ι Δ		T	-
66	_		A	+	-	
65 64	TPX2	-	A	-	-	-
	TPY1	-	A	+	ł	-
63	TPY2	-	А	-	-	-
TV IN	T	1	Т_	T	T	T
73	TV_VCC	-	P	-	-	-
74	TVGND	-	Р	-	-	-
75	TV_VRN	-	Α	-	-	-
76	TV_VRP	-	Α	-	-	-
77	TVIN1	-	A	-	-	-
78	TVIN0	-	A	-	-	-
KEYADC						
79	LRADC0	-	Α	-	-	-
TV OUT						
72	TVOUT	_	Α	_	I -	-
Clock	1	1	1 **	1	1	
52	HOSCO	1	Ι Δ	1	1	-
	HOSCO	-	A	-	-	-
51		-	А	-	-	-
Miscellaneous S		1	Τ.	Т	1	1
70	RESET	-	I	-	-	-
SIP DDR1						
33	SVREF	-	Р			
Power						
5,20,50	VCC-IO	_	Р	_	_	_
30,31,32,34,36	VCC-DRAM	-	P	-	-	-
22,35,71	VDD-CORE	-	P	-	-	-



4.2. **GPIO Multiplexing Functions**

Following table provides a description of the GPIO multiplexing functions of F1C200s.

Port	Default Function	IO Type	Default IO State	Default Pull-up/ down	Multiplexing Function 2	Multiplexing Function 3	Multiplexing Function 4	Multiplexing Function 5	Multiplexing Function 6
GPIOA	1				,			<u>, </u>	
PA0	GPIO	Α	DIS	Z	TPX1		DA_BCLK	UART1_RTS	SPI1_CS
PA1	GPIO	Α	DIS	Z	TPX2		DA_LRCK	UART1_CTS	SPI1_MOSI
PA2	GPIO	Α	DIS	Z	TPY1	PWM0	DA_IN	UART1_RX	SPI1_CLK
PA3	GPIO	Α	DIS	Z	TPY2	IR_RX	DA_OUT	UART1_TX	SPI1_MISO
GPIOB									
PB3	GPIO	1/0	DIS	Z	DDR_REF_D	IR_RX			
GPIOC	Г Т								
PC0	GPIO	1/0	DIS	Z	SPIO_CLK	SDC1_CLK			
PC1	GPIO	1/0	DIS	Pull-up	SPIO_CS	SDC1_CMD			
PC2	GPIO	1/0	DIS	Z	SPI0_MISO	SDC1_D0			
PC3	GPIO	1/0	DIS	Z	SPI0_MOSI	UARTO_TX			
GPIOD	I I								
PD0	GPIO	1/0	DIS	Z	LCD_D2	TWI0_SDA	RSB_SDA		EINTD0
PD1	GPIO	1/0	DIS	Z	LCD_D3	UART1_RTS			EINTD1
PD2	GPIO	1/0	DIS	Z	LCD_D4	UART1_CTS			EINTD2
PD3	GPIO	1/0	DIS	Z	LCD_D5	UART1_RX			EINTD3
PD4	GPIO	1/0	DIS	Z	LCD_D6	UART1_TX			EINTD4
PD5	GPIO	1/0	DIS	Z	LCD_D7	TWI1_SCK			EINTD5
PD6	GPIO	1/0	DIS	Z	LCD_D10	TWI1_SDA			EINTD6
PD7	GPIO	1/0	DIS	Z	LCD_D11	DA_MCLK			EINTD7
PD8	GPIO	1/0	DIS	Z	LCD_D12	DA_BCLK			EINTD8
PD9	GPIO	1/0	DIS	Z	LCD_D13	DA_LRCK			EINTD9
PD10	GPIO	1/0	DIS	Z	LCD_D14	DA_IN			EINTD10
PD11	GPIO	I/O	DIS	Z	LCD_D15	DA_OUT			EINTD11
PD12	GPIO	I/O	DIS	Z	LCD_D18	TWI0_SCK	RSB_SCK		EINTD12
PD13	GPIO	I/O	DIS	Z	LCD_D19	UART2_TX			EINTD13
PD14	GPIO	I/O	DIS	Z	LCD_D20	UART2_RX			EINTD14
PD15	GPIO	I/O	DIS	Z	LCD_D21	UART2_RTS	TWI2_SCK		EINTD15
PD16	GPIO	I/O	DIS	Z	LCD_D22	UART2_CTS	TWI2_SDA		EINTD16
PD17	GPIO	I/O	DIS	Z	LCD_D23	OWA_OUT			EINTD17
PD18	GPIO	1/0	DIS	Z	LCD_CLK	SPIO_CS			EINTD18
PD19	GPIO	1/0	DIS	Z	LCD_DE	SPI0_MOSI			EINTD19
PD20	GPIO	I/O	DIS	Z	LCD_HSYNC	SPIO_CLK			EINTD20
PD21	GPIO	1/0	DIS	Z	LCD_VSYNC	SPI0_MISO			EINTD21
GPIOE				•					
PE0	GPIO	1/0	DIS	Z	CSI_HSYNC	LCD_D0	TWI2_SCK	UARTO_RX	EINTE0
PE1	GPIO	I/O	DIS	Z	CSI_VSYNC	LCD_D1	TWI2_SDA	UARTO_TX	EINTE1
PE2	GPIO	1/0	DIS	Z	CSI_PCLK	LCD_D8	CLK_OUT		EINTE2
PE3	GPIO	I/O	DIS	Z	CSI_D0	LCD_D9	DA_BCLK	RSB_SCK	EINTE3
PE4	GPIO	1/0	DIS	Z	CSI_D1	LCD_D16	DA_LRCK	RSB_SDA	EINTE4
PE5	GPIO	I/O	DIS	Z	CSI_D2	LCD_D17	DA_IN		EINTE5
PE6	GPIO	I/O	DIS	Z	CSI_D3	PWM1	DA_OUT	OWA_OUT	EINTE6



PE7	GPIO	1/0	DIS	Z	CSI_D4	UART2_TX	SPI1_CS	EINTE7
PE8	GPIO	I/O	DIS	Z	CSI_D5	UART2_RX	SPI1_MOSI	EINTE8
PE9	GPIO	I/O	DIS	Z	CSI_D6	UART2_RTS	SPI1_CLK	EINTE9
PE10	GPIO	I/O	DIS	Z	CSI_D7	UART2_CTS	SPI1_MISO	EINTE10
PE11	GPIO	I/O	DIS	Z	CLK_OUT	TWI0_SCK	IR_RX	EINTE11
PE12	GPIO	I/O	DIS	Z	DA_MCLK	TWI0_SDA	PWM0	EINTE12
GPIOF								
PF0	GPIO	I/O	DIS	Z	SDC0_D1	DBG_MS	IR_RX	EINTF0
PF1	GPIO	1/0	DIS	Z	SDC0_D0	DBG_DI		EINTF1
PF2	GPIO	1/0	DIS	Z	SDC0_CLK	UARTO_RX		EINTF2
PF3	GPIO	I/O	DIS	Z	SDC0_CMD	DBG_DO		EINTF3
PF4	GPIO	1/0	DIS	Z	SDC0_D3	UARTO_TX		EINTF4
PF5	GPIO	I/O	DIS	Z	SDC0_D2	DBG_CK	PWM1	EINTF5

4.3. Detailed Pin Description

Pin Name	Description	Туре
GPIO		
PC[3:0]	Port C Bit[3:0]	1/0
PD[21:0]	Port D Bit[21:0]	1/0
PE[12:0]	Port E Bit[12:0]	1/0
PF[5:0]	Port F Bit[5:0]	1/0
USB		
USB-DM	USB DM Signal	A I/O
USB-DP	USB DP Signal	A I/O
UVCC	USB 3.3V power	Р
Audio Codec		
HPL	Headphone Left Output	AO
HPR	Headphone Right Output	AO
НРСОМ	Headphone Common Reference	AO
НРСОМГВ	Headphone Common Reference Feedback Input	AI
HPVCC	Headphone Amplifier Power	Р
FMINL	FM in Left Input	AI
FMINR	FM in Right Input	AI
LINEIN	Line in Input	Al
MICIN	Microphone Input	AI
VRA1	Reference Voltage	AO
VRA2	Reference Voltage	AO
AVCC	Analog Power	Р
AGND	Analog Ground	G
Digital Audio		
DA_MCLK	Digital Audio Master Clock	0
DA_BCLK	Digital Audio sample rate Clock	1/0



DA IDCK	District Andia Left & District descript Clark	1/0
DA_LRCK	Digital Audio Left & Right channel Clock	1/0
DA_IN	Digital Audio Data Out	1
DA_OUT RSB	Digital Audio Data in	0
	pen et al	1/0
RSB_SCK	RSB Clock	1/0
RSB_SDA Touch Panel	RSB Data	1/0
	- 10 May 1	1
TPX1	Touch Panel X1 Input	Al
TPX2	Touch Panel X2 Input	Al
TPY1	Touch Panel Y1 Input	Al
TPY2 TV-Out	Touch Panel Y1 Input	Al
		1.0
TV-IN	TV CVBS Output	AO
	TV CVPC land to	Al
TVIN0	TV CVBS Input 0	Al
TVIN1	TV CVBS Input 1	Al
TVACALE	TV Analog VCC for TVIN and TVOUT	P
TVAGND	TV Analog GND for TVIN and TVOUT	G
TVIN_VRP	TV Input Voltage Reference Positive	Al
TVIN_VRN Clock	TV Input Voltage Reference Negative	Al
	24MUs Counted Louvet	1
HOSCI	24MHz Crystal Input	Al
Miscellaneous Signal	24MHz Crystal Output	AO
	Chia Basat Ciasal	1.
RESET#	Chip Reset Signal	1
PWM[1:0] ADC	Pulse Width Modulation Output	0
	ADG larget fee Kee	1.
LCD	ADC Input for Key	1
LCD[7:2]	LCD Data Bus Bit[7:2]	0
	LCD Data Bus Bit[7:2] LCD Data Bus Bit[15:10]	0
LCD[15:10]		
LCD[23:18] LCD_CLK	LCD Data Bus Bit[23:18] LCD Clock	0
LCD_DE LCD_HSYNC	LCD Data Enable LCD Horizon Sync	0
		0
LCD_VSYNC SPI(x=[1:0])	LCD Vertical Sync	0
SPIX_MOSI	SPI Master Output Slave Input	1/0
	SPI Master Output Slave Input SPI Master Input Slave Output	1/0
SPIx_MISO		
SPIx_CS	SPI Clock	1/0
SPIx_CLK	SPI Clock	1/0



UART(x=[2:0])			
UARTx_TX	UART Data Transmit	0	
UARTx_RX	UART Data Receive	I	
UARTx_CTS	UART Clear to Send	1	
UARTx_RTS	UART Request to Send	0	
IR			
IR_RX	IR Receive Signal	1	
CSI			
CSI_PCLK	CSI Pixel Clock signal	I	
CSI_HSYNC	CSI Horizontal Synchronization Signal	1	
CSI_VSYNC	CSI Vertical Synchronization Signal	1	
CSI_D[7:0]	CSI Data Bit[7:0]	1	
SDC			
SDC0_D[3:0]	SD/MMC/SDIO Data Bit[3:0]	1/0	
SDC0_CLK	SD/MMC/SDIO Clock	0	
SDC0_CMD	SD/MMC/SDIO Command	1/0	
SDC1_D0	SD/MMC/SDIO Data Bit0	1/0	
SDC1_CLK	SD/MMC/SDIO Clock	0	
SDC1_CMD	SD/MMC/SDIO Command	1/0	
TWI(x=[2:0])(Open-Drain	n)		
TWIx-SCK	TWI Clock	1/0	
TWIx-SDA	TWI Data	1/0	



5. Electrical Characteristics

5.1. Absolute Maximum Ratings

Functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute maximum rated conditions for extended periods may affect device reliability.

Symbol	Parameter	Min	Max	Unit
T _{stg}	Storage Temperature	-65	150	°C
I _{I/O}	In/Out current for input and output	-40	40	mA
VCC-IO	Power Supply for I/O	-0.3	3.6	V
AVCC	Power Supply for Codec	-0.3	3.1	V
TV_AVCC	Power Supply for TV	-0.3	3.6	V
VDD-CORE	Power Supply for Internal Digital Logic	-0.3	1.3	V
UVCC	Power Supply for USB	-0.3	3.6	V
VCC-DRAM	Power Supply for DDR1	-0.3	2.7	V

5.2. Recommended Operating Conditions

Symbol	Parameter	Min	Тур	Max	Unit
Ta	Ambient Operating Temperature[Commercial]	-20	=	85	°C
VCC-IO	Power Supply for I/O	3.0	3.3	3.6	V
AVCC	Power Supply for Codec	2.5	2.8	3.1	V
TV_AVCC	Power Supply for TV	3.0	3.3	3.6	V
VDD-CORE	Power Supply for Internal Digital Logic	1.0	1.1	1.2	٧
UVCC	Power Supply for USB	3.0	3.3	3.6	V
VCC-DRAM	Power Supply for DDR1	2.3	2.5	2.7	V

5.3. DC Electrical Characteristics

Symbol	Parameter	Min	Тур	Max	Unit
V _{IH}	High-Level Input Voltage	0.7 * VCC-IO	-	VCC-IO + 0.3	V
V _{IL}	Low-Level Input Voltage	-0.3	-	0.3 * VCC-IO	V
R _{PU}	Input pull-up resistance	50	100	150	ΚΩ
R _{PD}	Input pull-down resistance	50	100	150	ΚΩ
I _{IH}	High-Level Input Current	-	-	10	uA
I _{IL}	Low-Level Input Current	-	-	10	uA
V _{OH}	High-Level Output Voltage	VCC-IO -0.2	-	VCC-IO	V
V _{OL}	Low-Level Output Voltage	0	-	0.2	V
l _{oz}	Tri-State Output Leakage Current	-10	-	10	uA



C _{IN}	Input Capacitance	-	-	5	pF
C _{OUT}	Output Capacitance	-		5	pF

5.4. Oscillator Electrical Characteristics

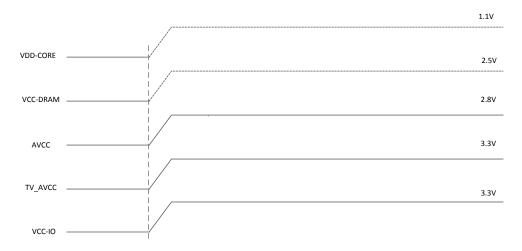
The 24.000MHz crystal is connected between the OSC24MI and OSC24MO. The following table lists the 24.000MHz crystal specifications.

Symbol	Parameter	Min	Тур	Max	Unit	
1/(t _{CPMAIN})	Crystal Oscillator Frequency Range	-	24.000	-	MHz	
t _{st}	Startup Time	-	-	-	ms	
	Frequency Tolerance at 25°C	-50	-	50	ppm	
	Oscillation Mode	Fundamental		-	-	
	Maximum Change Over Temperature Range	-50	-	50	ppm	
P _{ON}	Drive Level	-	-	300	uW	
C_L	Equivalent Load Capacitance	12	18	22	pF	
R _S	Series Resistance(ESR)	-	25	-	Ω	
	Duty Cycle	30	50	70	%	
C _M	Motional Capacitance	-	-	-	pF	
C _{SHUT}	Shunt Capacitance	5	6.5	7.5	pF	
R _{BIAS}	Internal Bias Resistor	0.4	0.5	0.6	ΜΩ	

5.5. Power Up/Down Sequence

The external voltage regulator and other power-on devices must provide the processor with a specific sequence of power and resets to ensure proper operations.

Power Up Sequence

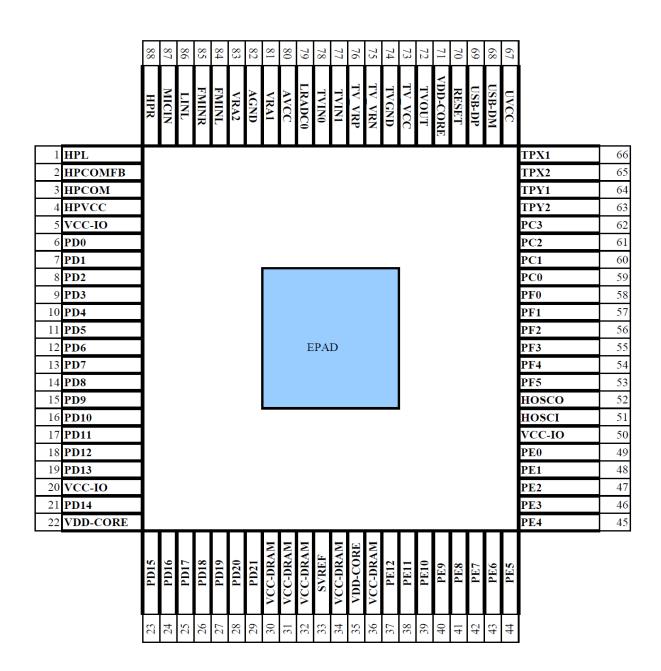


No special restrictions for power down sequence.



6.Pin Assignment

6.1. Pin Map





6.2. Package Dimension

The following figure shows the top, bottom, and side views of F1C200s package dimension.

